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REVISIONS

P	LTR	DESCRIPTION	DATE	DWN	APVD
	V7	REVISED ECR-23-185274	06SEP2023	AG	RK

18.6±0.5

7±0.3

3.5±0.3

2xø2.4

LOGO MARK

1

2

3

4

5

6

7

A

15.8±0.5

12.8

5.9

3.15

(7.35)

2.35

0

3.5

7

10.5

12.5

16

19.5

23

25

28.5

32

35.5

(56.8)

50.2

(43.2)

40.2

(1)

(2)

PC BOARD DIMENSION
プリント基板取付穴

THICKNESS: 1.6±0.15
TOLERANCE: ±0.1

2xø3.2

7.35

0

3.5

7

10.5

12.5

16

19.5

23

25

28.5

32

35.5

18xø1

4.6

5

15MAX

50.2

4±0.5

0.64
(THICKNESS)

4.6

(5)

173862

1

2

3

4

TO BE MEASURED BETWEEN [A] AND 2.

TO BE MATE WITH PLUG HSG SMOOTHLY.

TO BE USE M3 TAPPING SCREW JIS B1115 OR 1122 (TYPE2 OR 4) BEFORE SOLDER (TIGHTENING TORQUE: 0.4N·m (4Kg·cm) MAX.)

CIRCUIT NUMBER; SEE FIG.1.

1

2

3

4

[A] 面より2mmの範囲で測定。

相手ハウジングと所定の機能を満足して嵌合できること。

プリント基板への取付は、JIS B1115又は1122、M3×6ナベ (2種又は4種)のタッピングネジで締付けた後ハンダ付する。
(締付トルク: 0.4N·m (4Kg·cm)以下)

回路番号: FIG.1参照のこと。

TOLERANCE UNLESS OTHERWISE SPECIFIED:
一般公差

0<≦ 10 : ±0.2

10<≦ 30 : ±0.25

30<≦ 100 : ±0.3

ANGLE : ±3°

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DIMENSIONS: mm

0 PLC ±

1 PLC ±

2 PLC ±

3 PLC ±

4 PLC ±

ANGLES ±

FINISH

MATERIAL
HSG; PBT
CONTACT; BRASS

SEE TABLE

TOLERANCE UNLESS OTHERWISE SPECIFIED:
一般公差

0<≦ 10 : ±0.2

10<≦ 30 : ±0.25

30<≦ 100 : ±0.3

ANGLE : ±3°

USED MATERIAL
FLAMMABILITY

SOLDERING SIDE
半田付け部

CONTACT SIDE
接触部側

CONTACT FINISH
コンタクト仕上

GOLD PLATED CIRCUIT NO.
金めっき回路番号

PRE-TIN CIRCUIT NO.
錫めっき回路番号

COLOR
色

PART NUMBER
製品型番

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DWN T.SHINOHARA 15AUG05

CHK K.BETSUI 15AUG05

APVD K.BETSUI 15AUG05

PRODUCT SPEC 108-5216

APPLICATION SPEC

WEIGHT 9.6 g

CUSTOMER DRAWING

TE Connectivity

070 SERIES MULTI-LOCK I/O CONNECTOR
18POSITION CAP HOUSING ASSEMBLY

SIZE A2 CAGE CODE 00779 DRAWING NO. C-173862 RESTRICTED TO

SCALE 2:1 SHEET 1 OF 1 REV V7

1471-9 (1/15)